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6 February 2026

Cookpad Inc.
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Non-Payment of Dividends Out of Surplus 2025

Cookpad Inc. (the “Company”) hereby announces that its Board of Directors resolved today not to pay dividends out of surplus on shares of the Company’s stock held as of 31 December 2025, as outlined below.

1. Detailed description of dividends

	Dividend for FY2025	Most recent forecast (announced on 7 Nov. 2025)	Dividend paid for FY2024 (ended 31 Dec. 2024)
Record date	31 December 2025	31 December 2025	31 December 2024
Dividend per share	0 yen	0 yen	0 yen
Total payment	-	-	-
Effective date	-	-	-
Source of dividends	-	-	-

2. Reasons for non-payment

To focus on building the foundation for further growth, the Company has decided not to pay dividends, prioritising investment for business expansion through service development, user base boosting and better branding over other uses of profits earned from its business activities.